

1 Standard characteristics

Standard characteristics described below are just examples of the 3850 Group (spec. A)'s characteristics and are not guaranteed. For rated values, refer to "3.1 Electrical characteristics" of Datasheet.

1.1 Flash memory version power source current standard characteristics

Figure. 1 to Figure. 7 show flash memory version (M38507F8A) power source current standard characteristics.

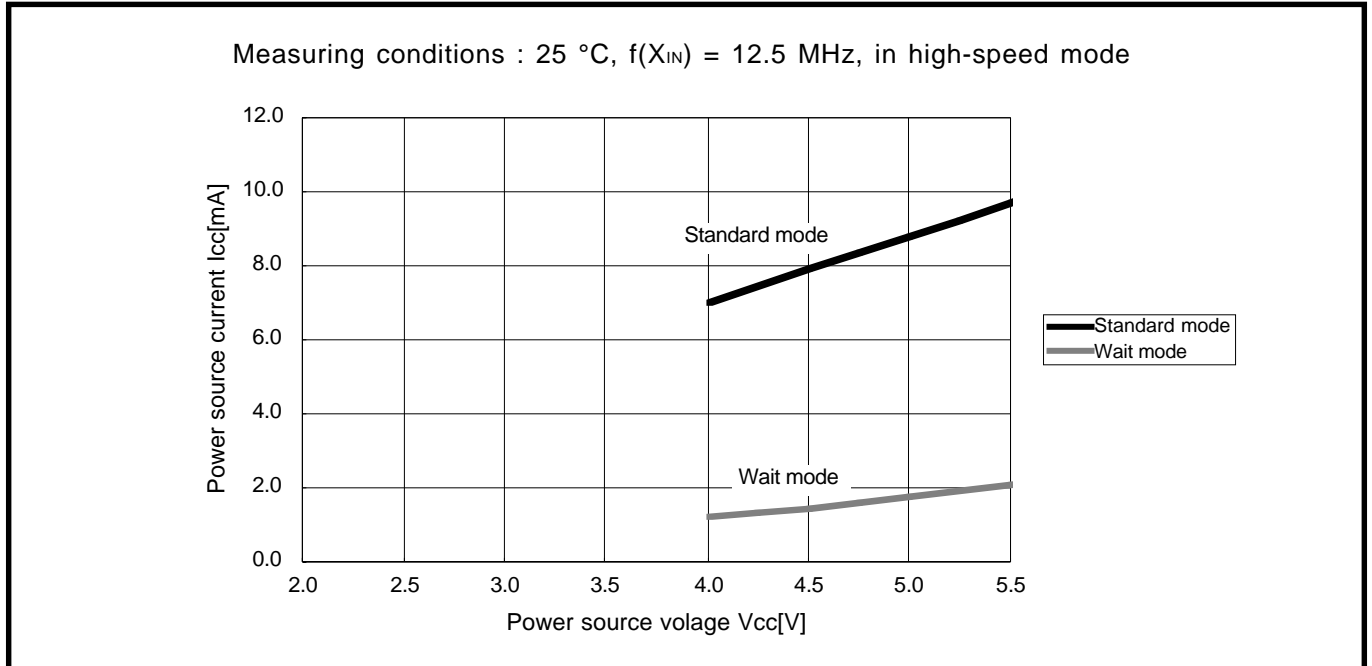


Fig. 1 Flash memory version power source current standard characteristics (in high-speed mode, $f(X_{IN}) = 12.5$ MHz)

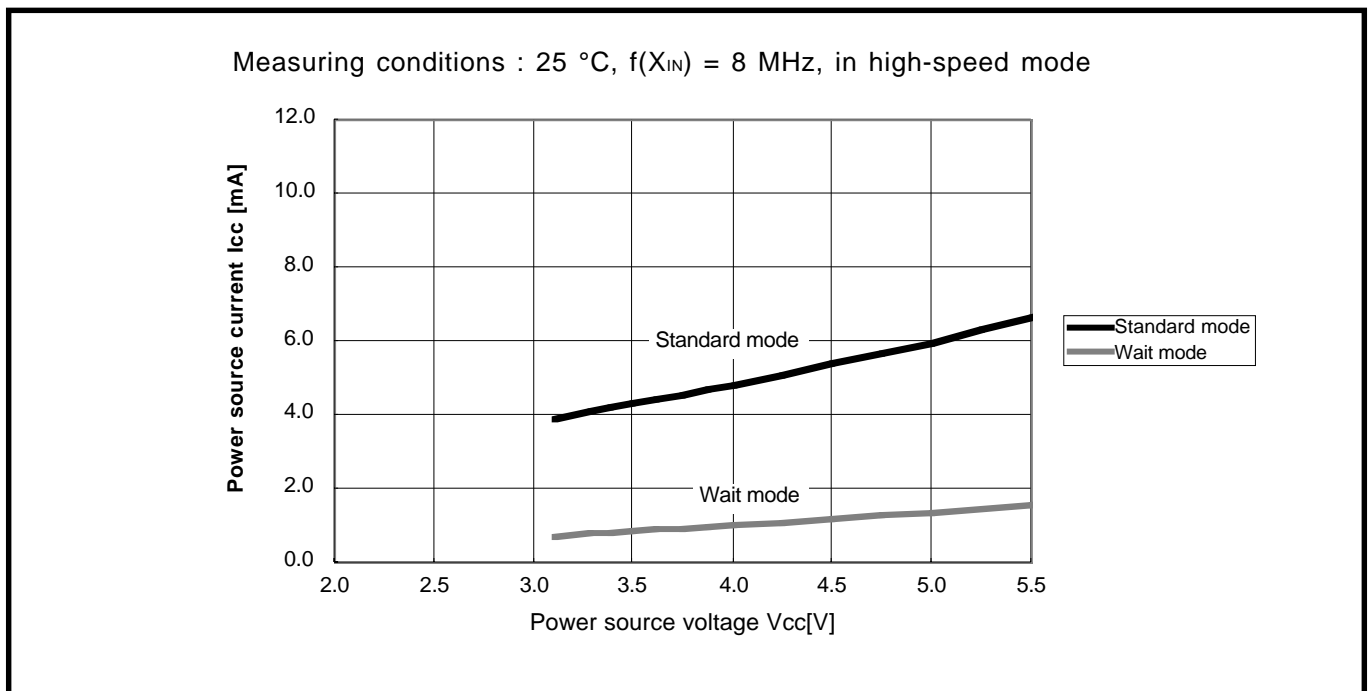


Fig. 2 Flash memory version power source current standard characteristics (in high-speed mode, $f(X_{IN}) = 8$ MHz)

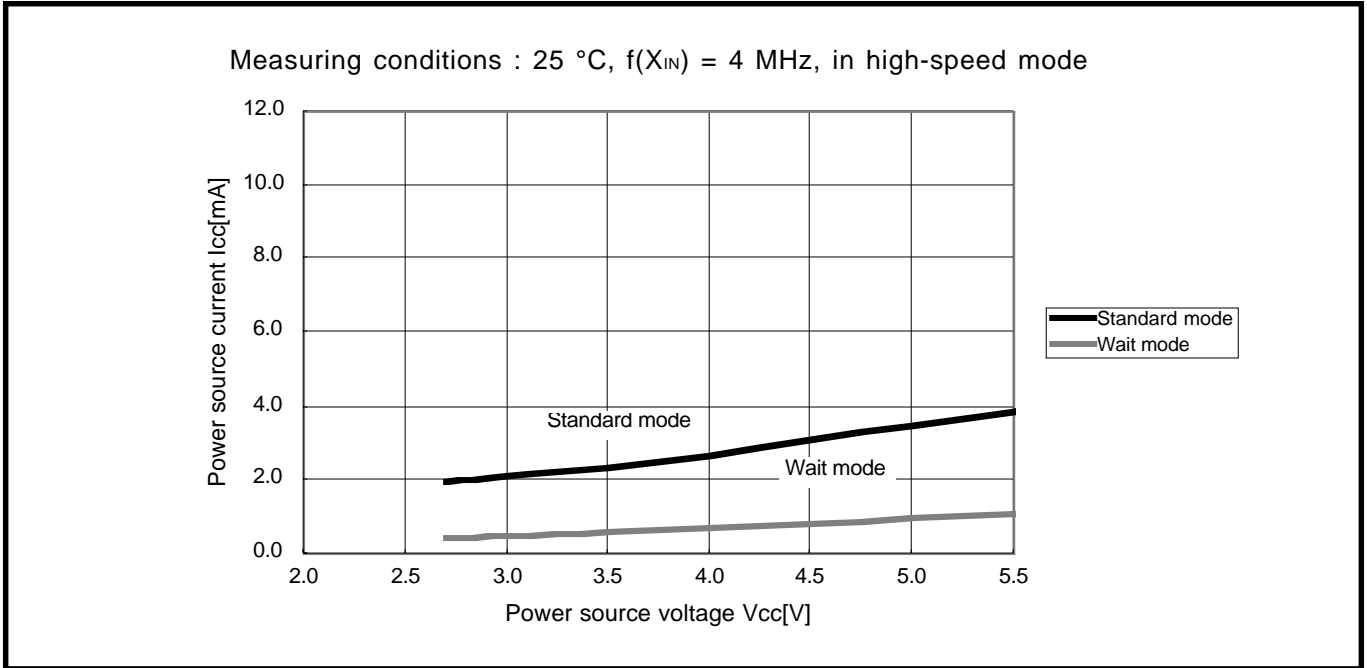


Fig. 3 Flash memory version power source current standard characteristics (in high-speed mode, $f(X_{IN}) = 4$ MHz)

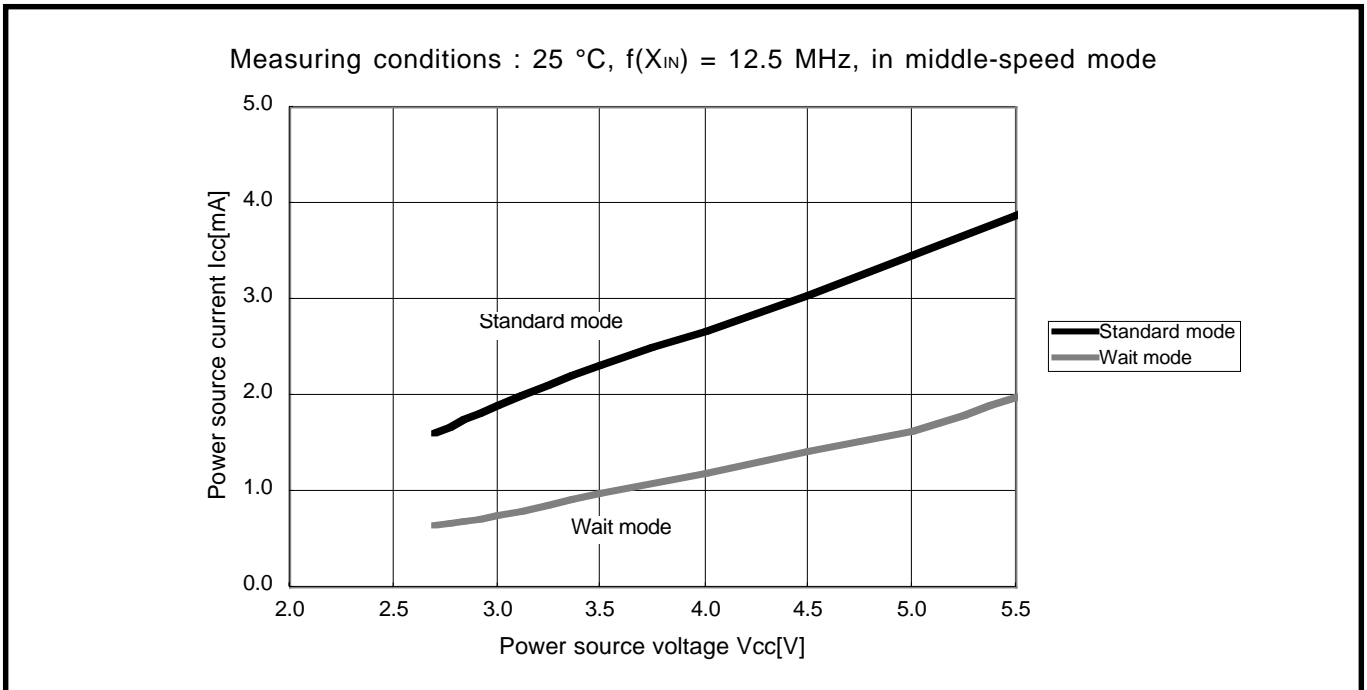


Fig. 4 Flash memory version power source current standard characteristics (in middle-speed mode, $f(X_{IN}) = 12.5$ MHz)

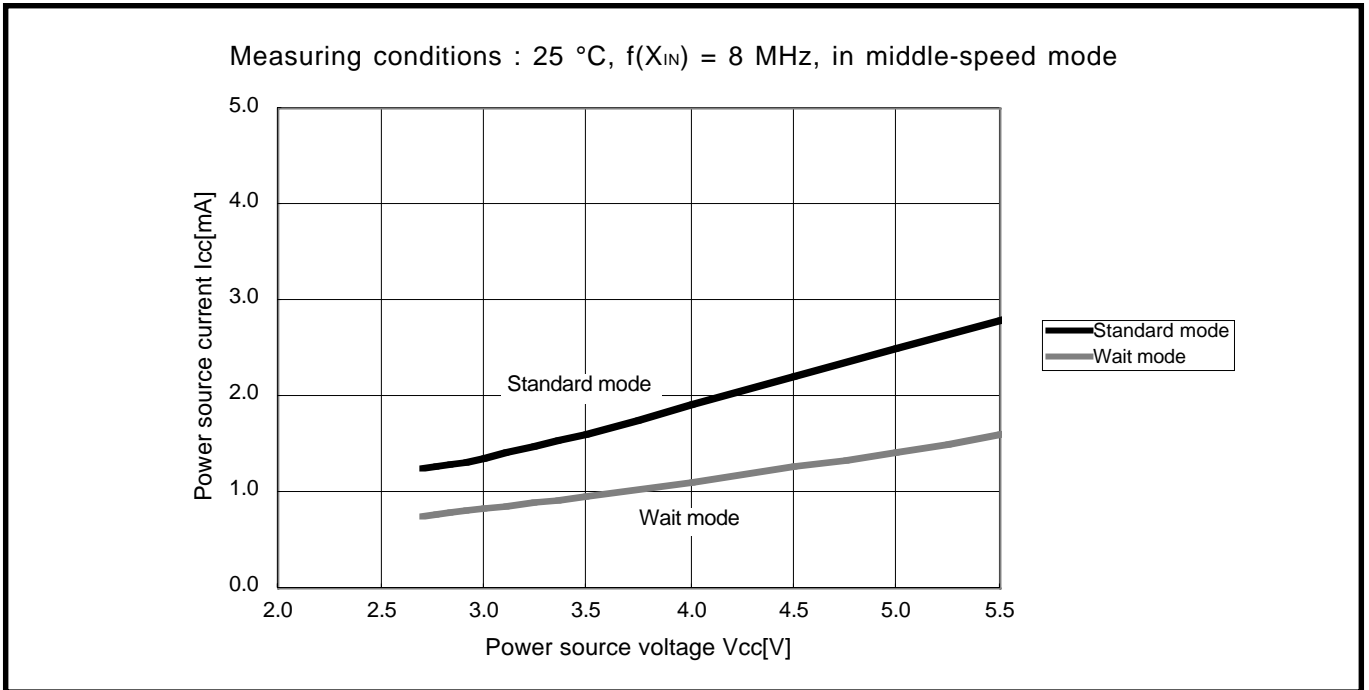


Fig. 5 Flash memory version power source current standard characteristics (in middle-speed mode, $f(X_{IN}) = 8$ MHz)

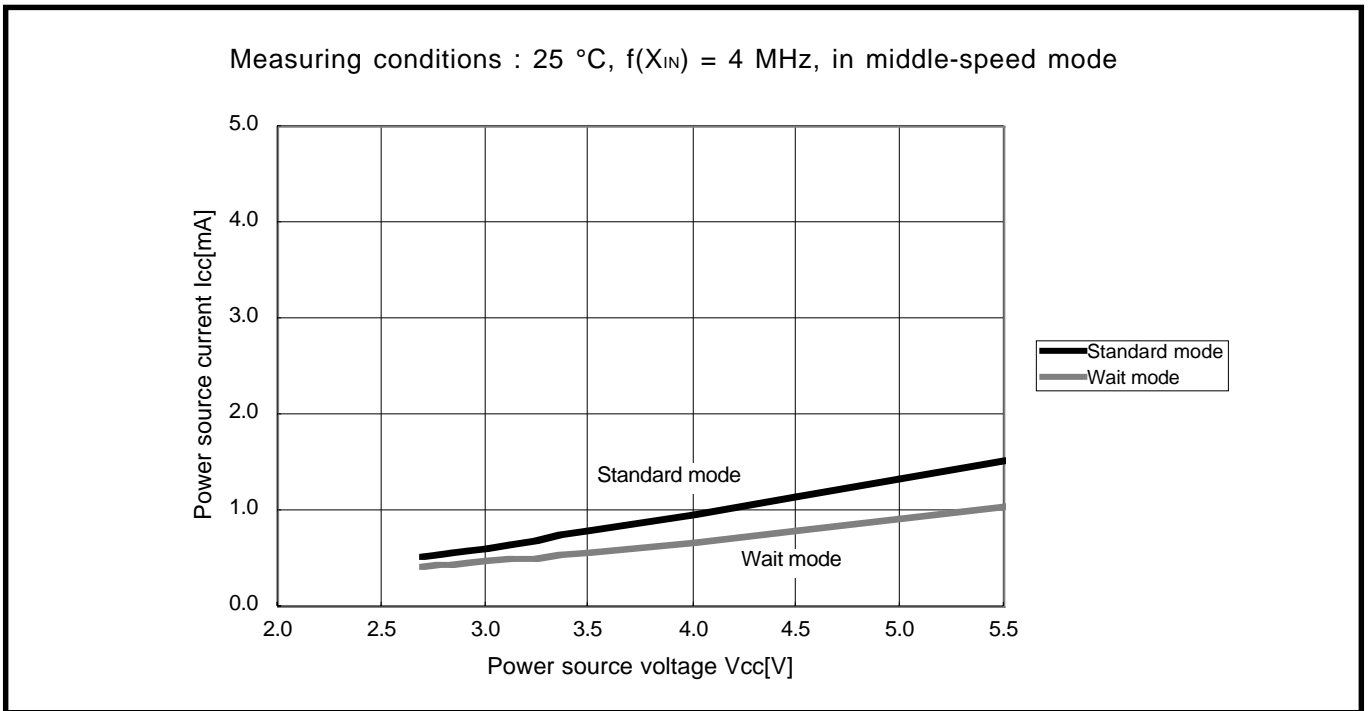


Fig. 6 Flash memory version power source current standard characteristics (in middle-speed mode, $f(X_{IN}) = 4$ MHz)

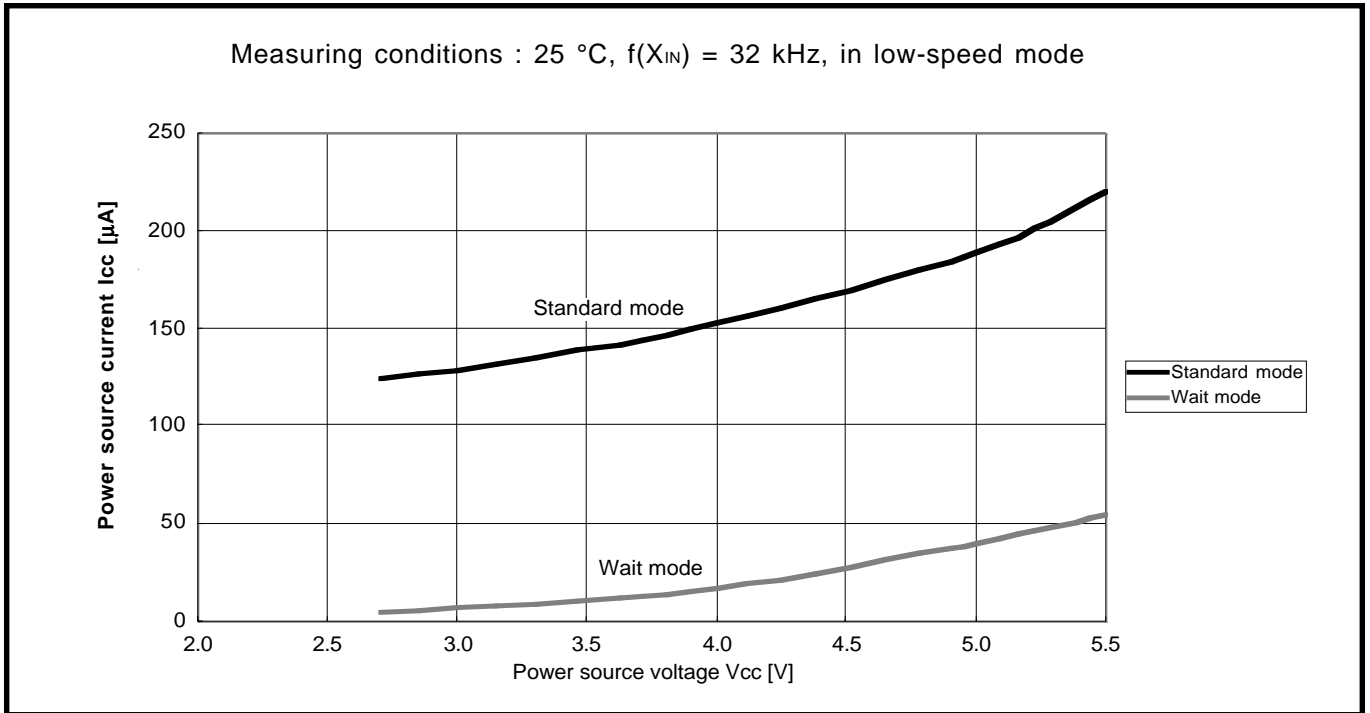


Fig. 7 Flash memory version power source current standard characteristics (in low-speed mode)

1.2 Mask ROM version power source current standard characteristics

Figure. 8 – Figure. 14 show mask ROM version (M38503M2A, M38503M4A, M38504M6A, M38507M8A) power source current standard characteristics.

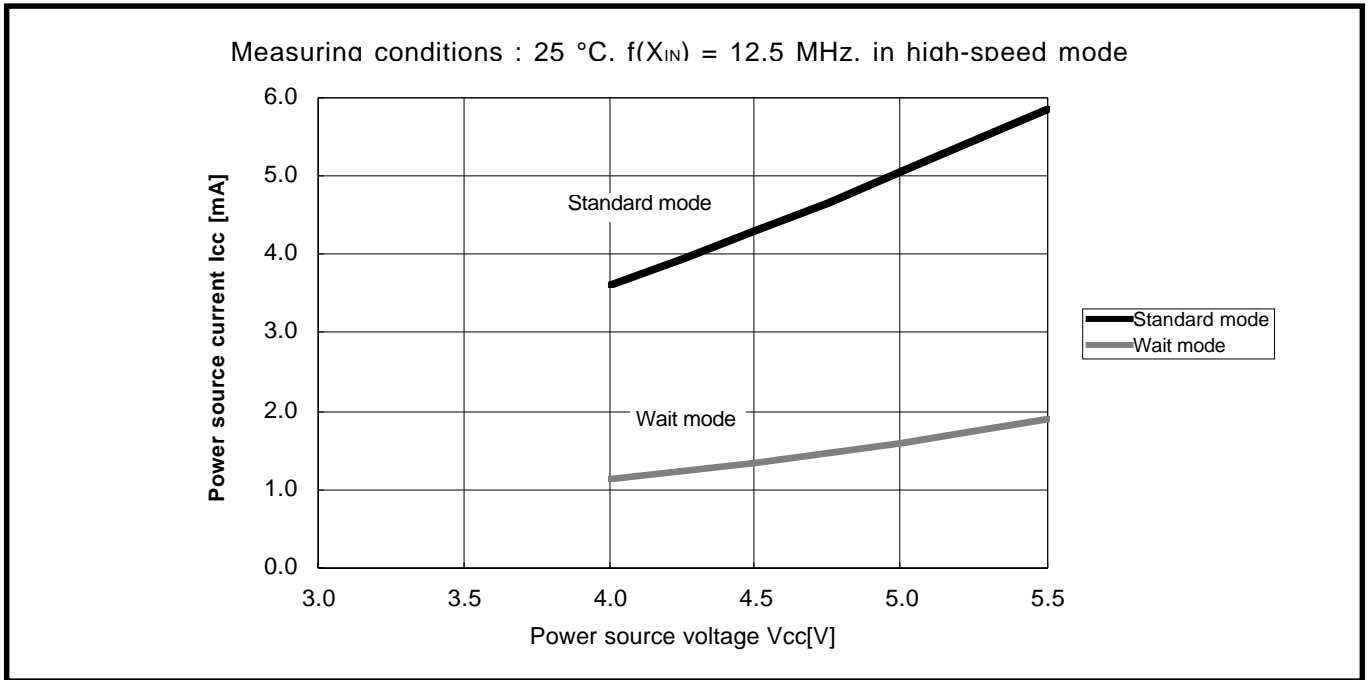


Fig. 8 Mask ROM version power source current standard characteristics (in high-speed mode, $f(X_{IN}) = 12.5$ MHz)

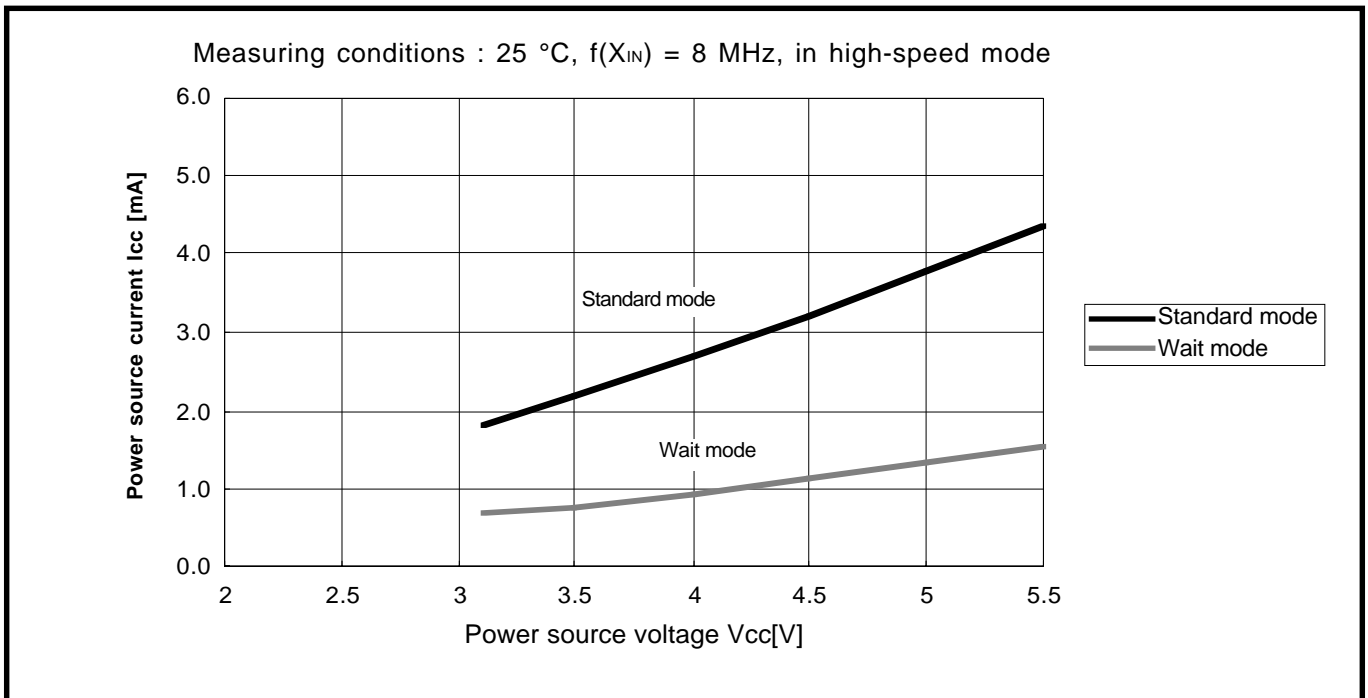


Fig. 9 Mask ROM version power source current standard characteristics (in high-speed mode, $f(X_{IN}) = 8$ MHz)

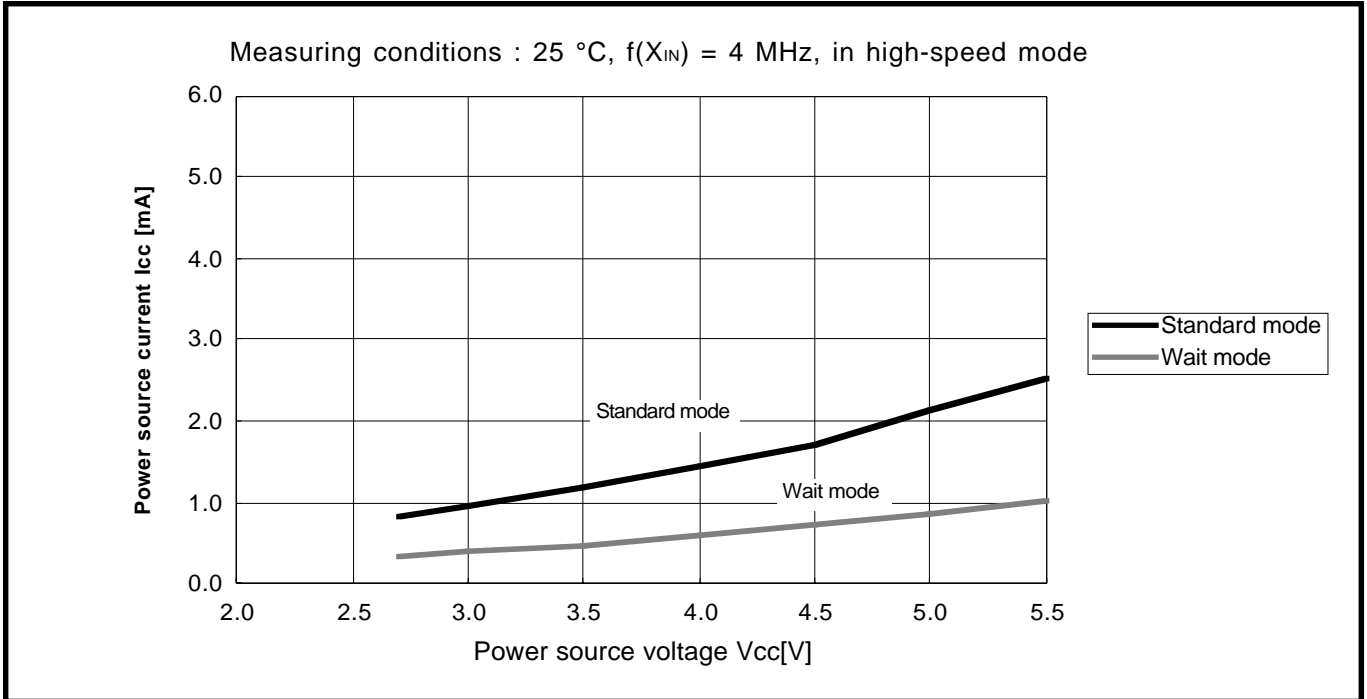


Fig. 10 Mask ROM version power source current standard characteristics (in high-speed mode, $f(X_{IN}) = 4$ MHz)

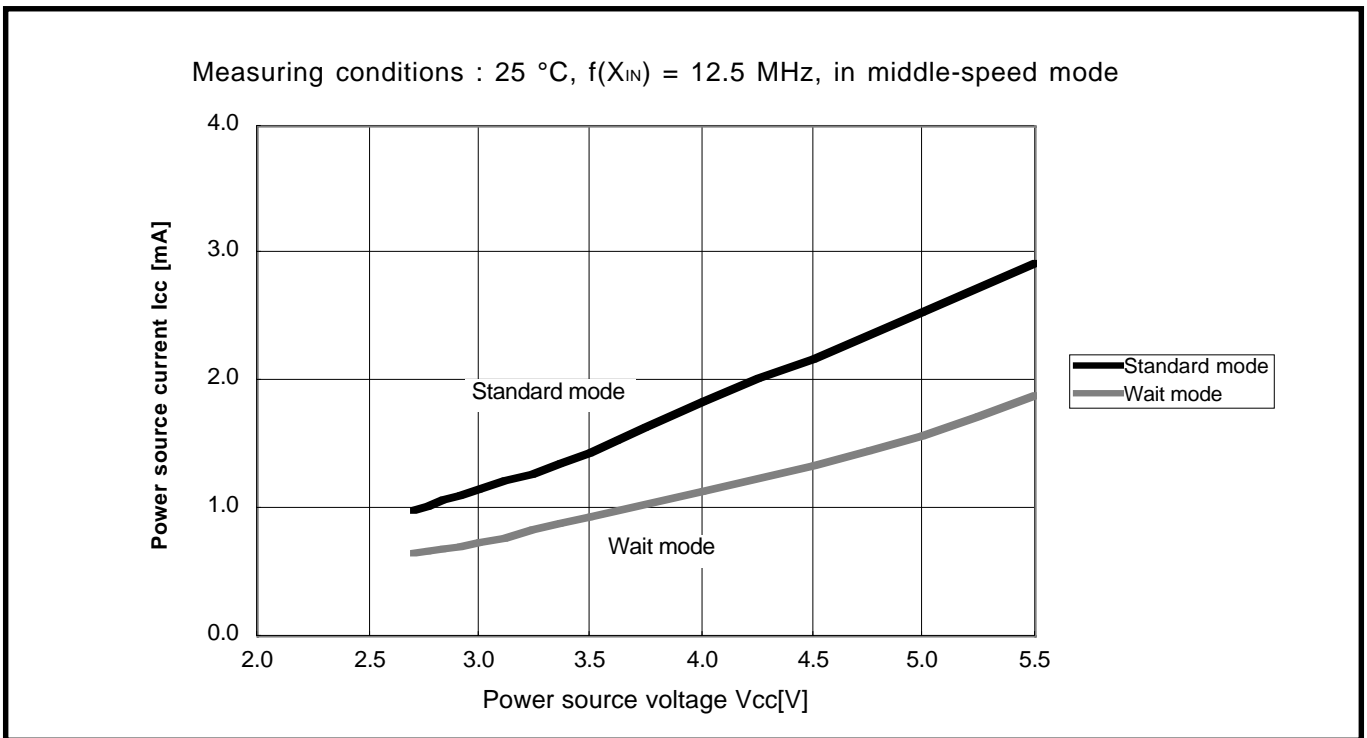


Fig. 11 Mask ROM version power source current standard characteristics (in middle-speed mode, $f(X_{IN}) = 12.5$ MHz)

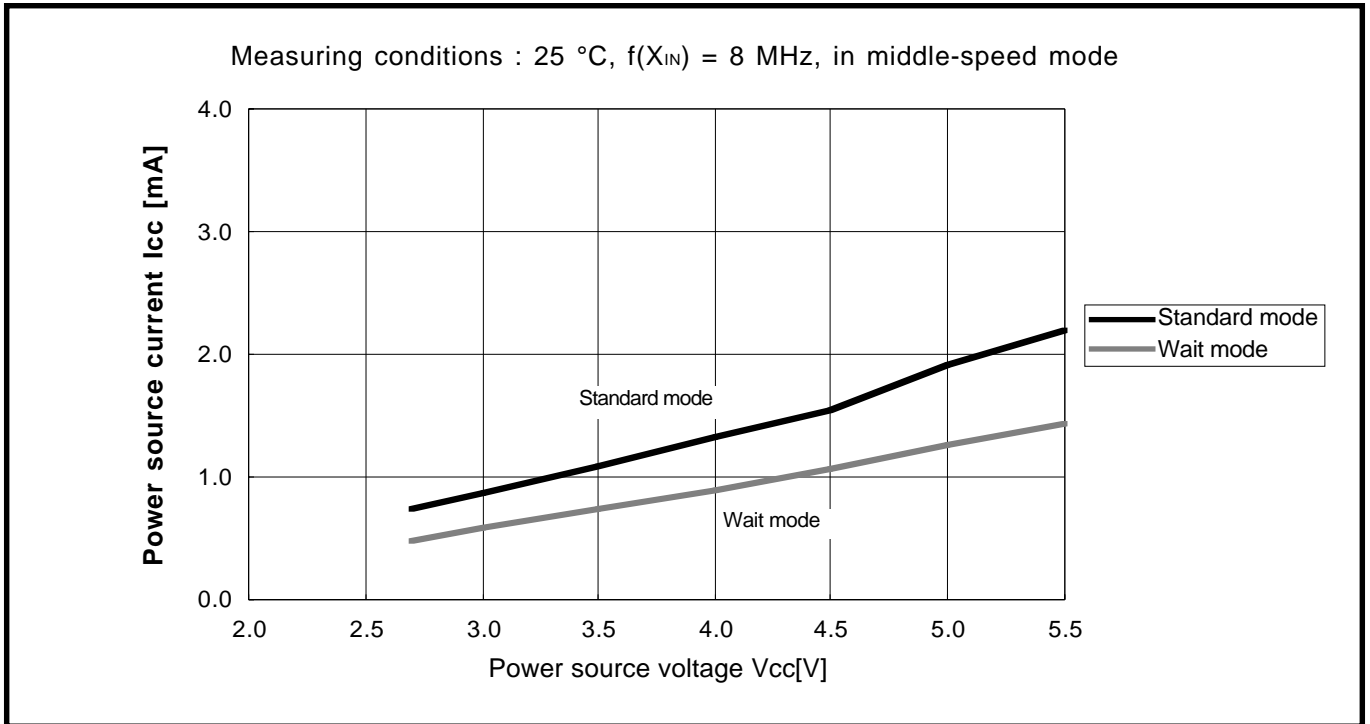


Fig. 12 Mask ROM version power source current standard characteristics (in middle-speed mode, $f(X_{IN}) = 8 \text{ MHz}$)

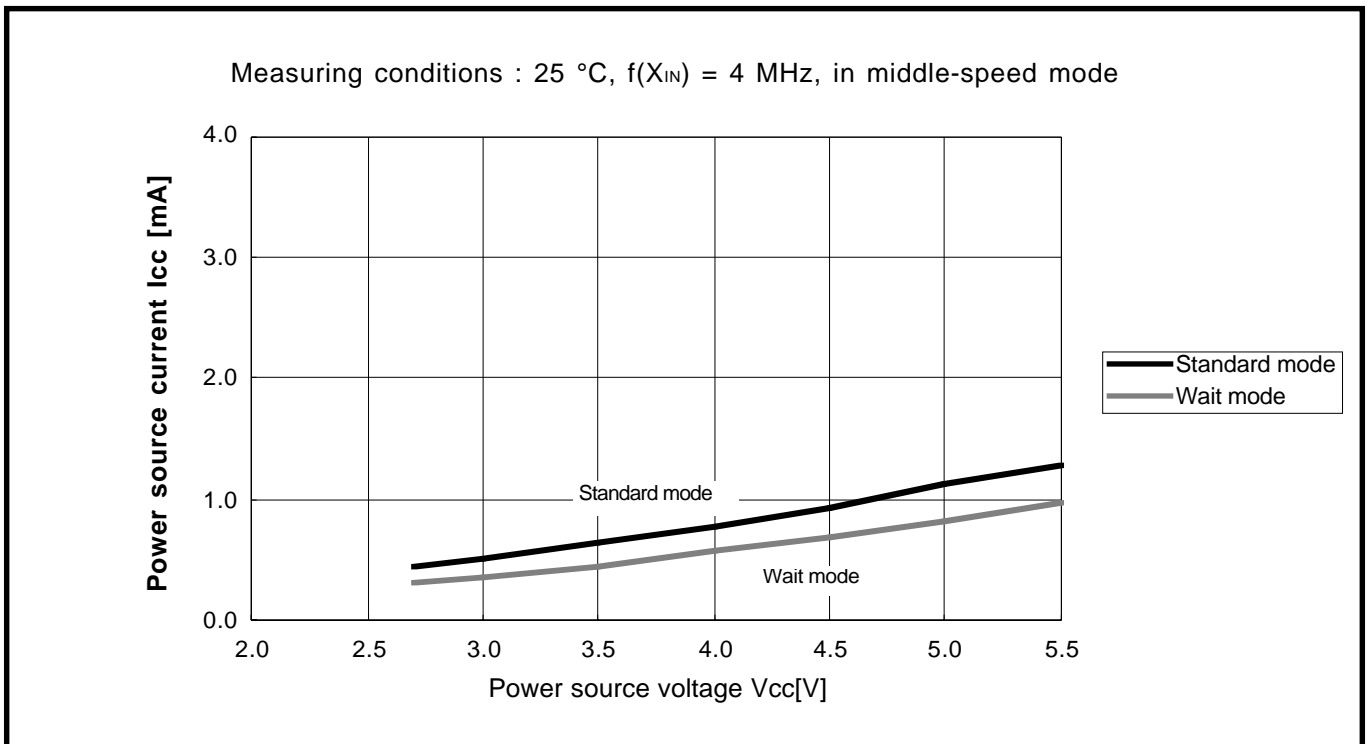


Fig. 13 Mask ROM version power source current standard characteristics (in middle-speed mode, $f(X_{IN}) = 4 \text{ MHz}$)

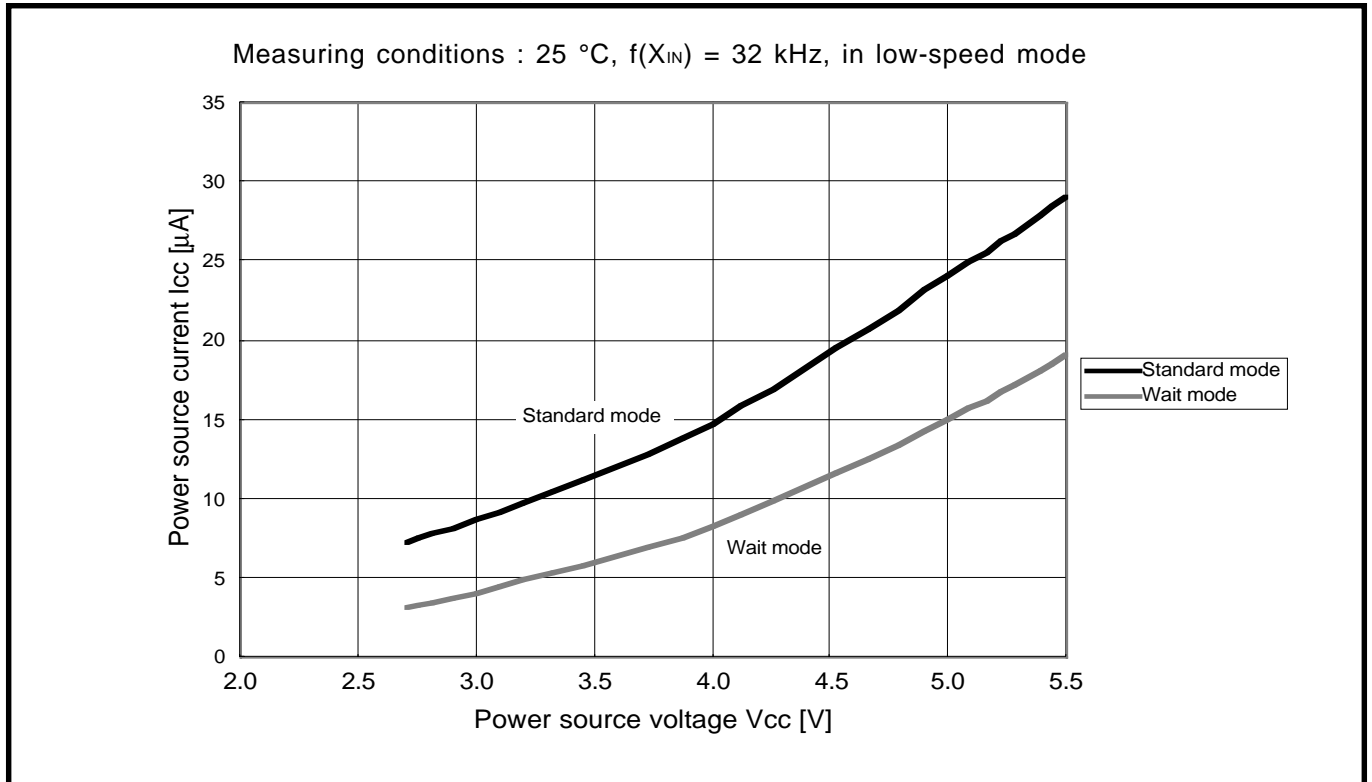


Fig. 14 Mask ROM version power source current standard characteristics (in low-speed mode)

1.3 Flash memory version port standard characteristics

Figure. 15, Figure. 16, Figure. 17 and Figure. 18 show flash memory version (M38507F8A) port standard characteristics.

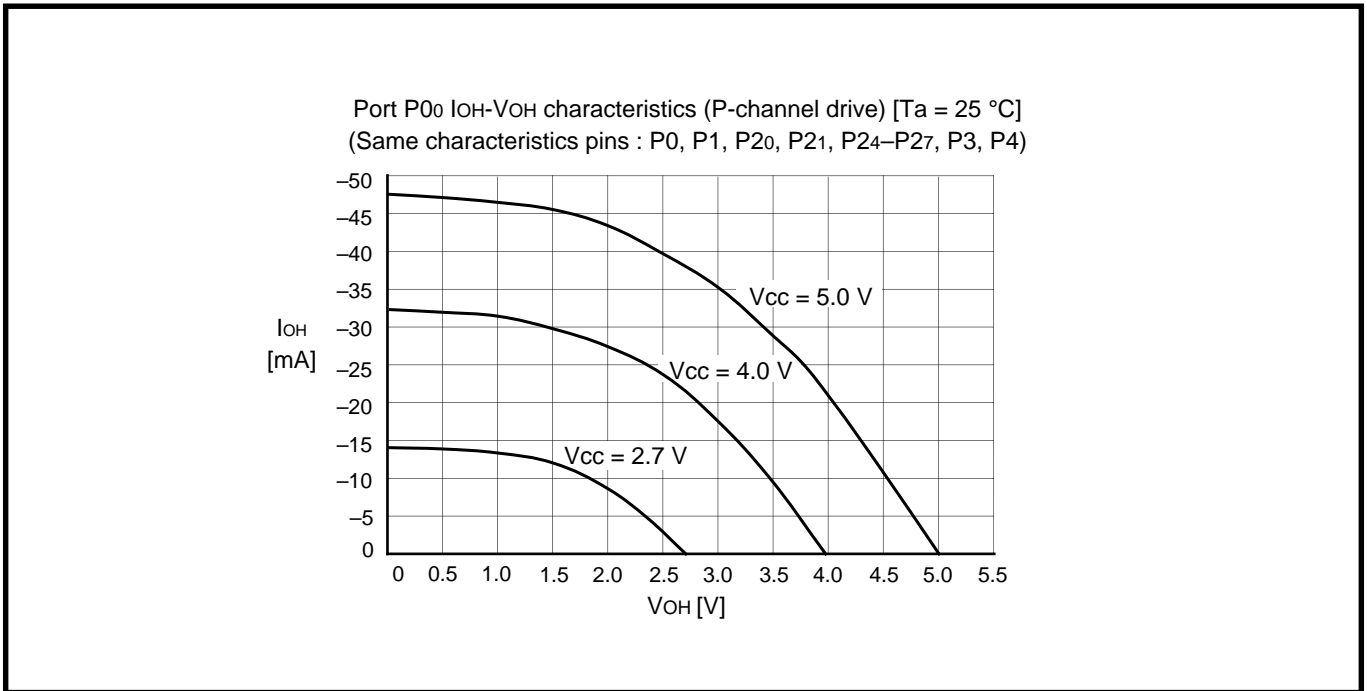


Fig. 15 CMOS output port P-channel side characteristics (Ta = 25 °C)

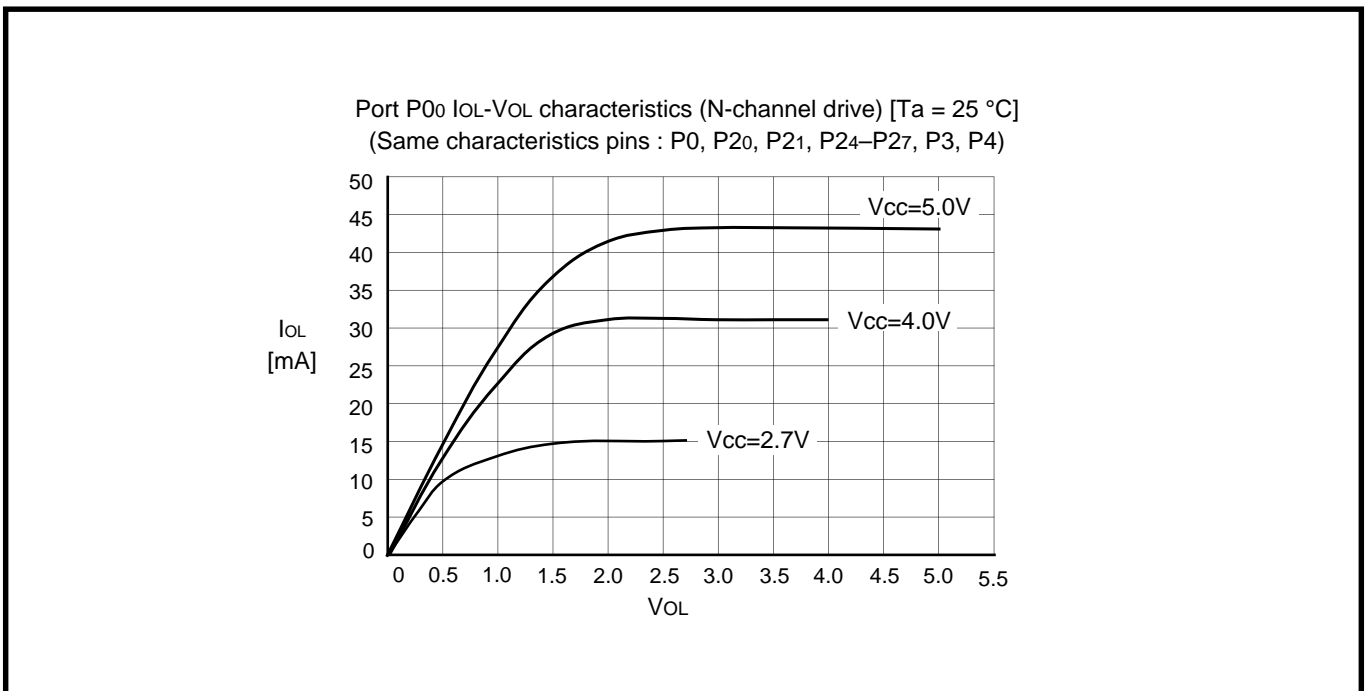


Fig. 16 CMOS output port N-channel side characteristics (Ta = 25 °C)

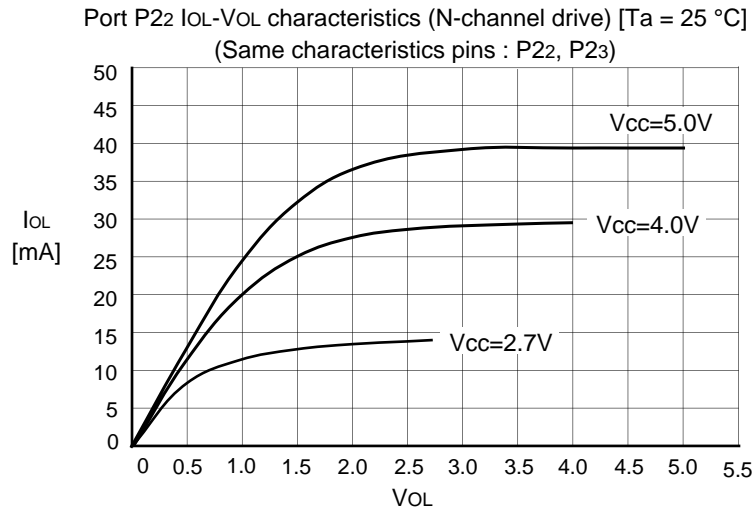


Fig. 17 N-channel open-drain output port N-channel side characteristics (Ta = 25 °C)

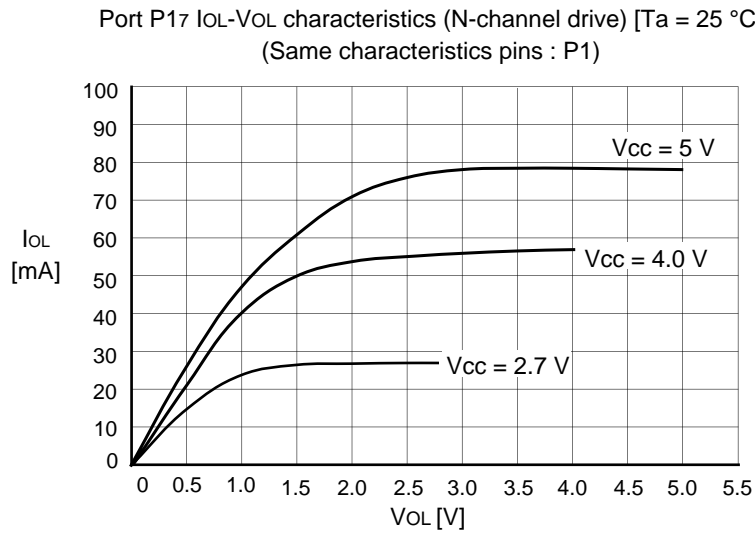


Fig. 18 CMOS large current output port N-channel side characteristics (Ta = 25 °C)

1.4 Mask ROM version port standard characteristics

Figure. 19, Figure. 20, Figure. 21 and Figure. 22 show mask ROM version (M38503M2HA, M38503M4HA, M38504M6A, M38507M8A) port standard characteristics.

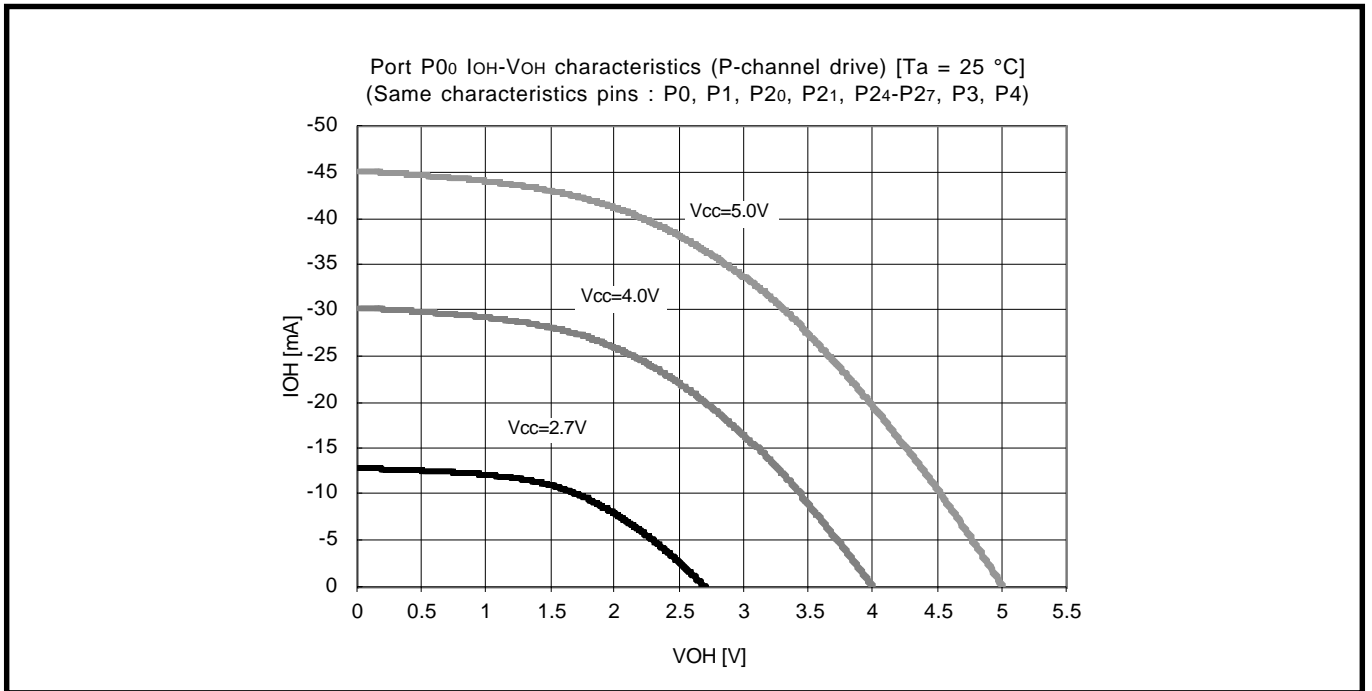


Fig. 19 CMOS output port P-channel side characteristics (Ta = 25 °C)

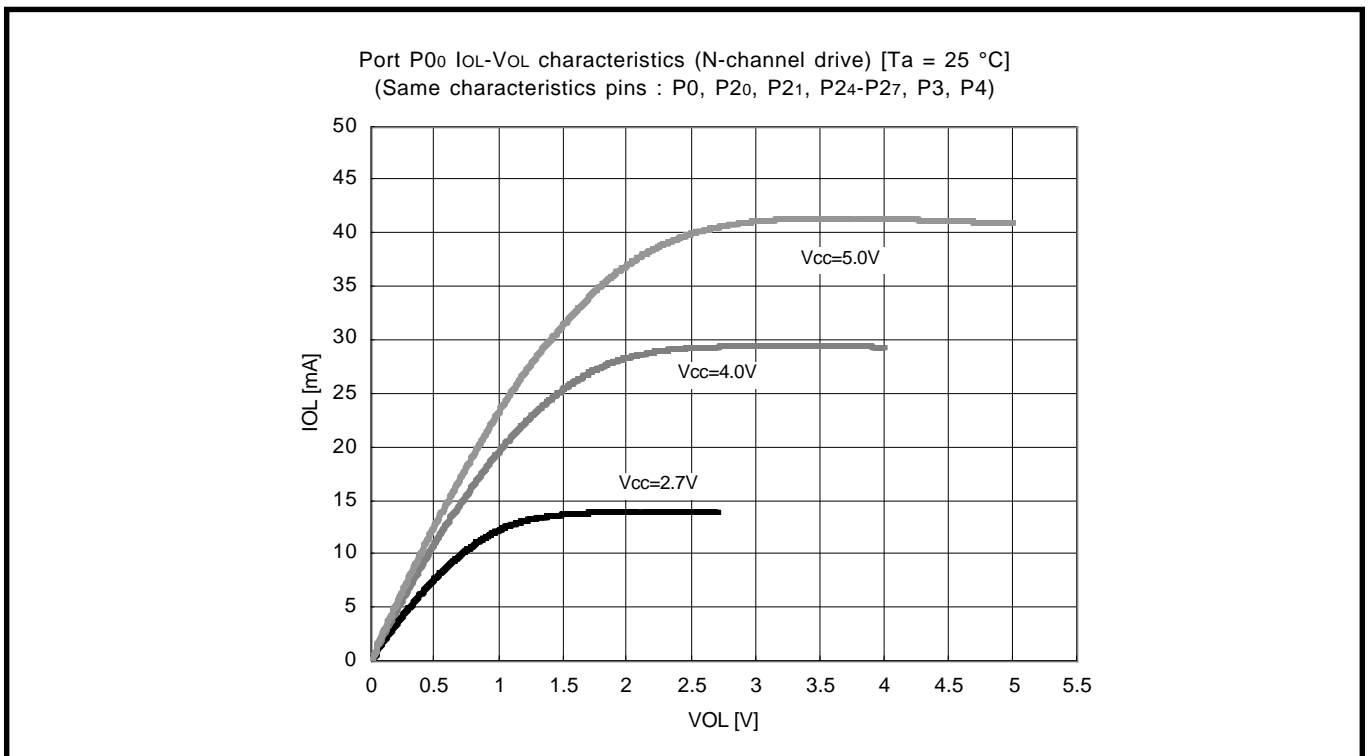


Fig. 20 CMOS output port N-channel side characteristics (Ta = 25 °C)

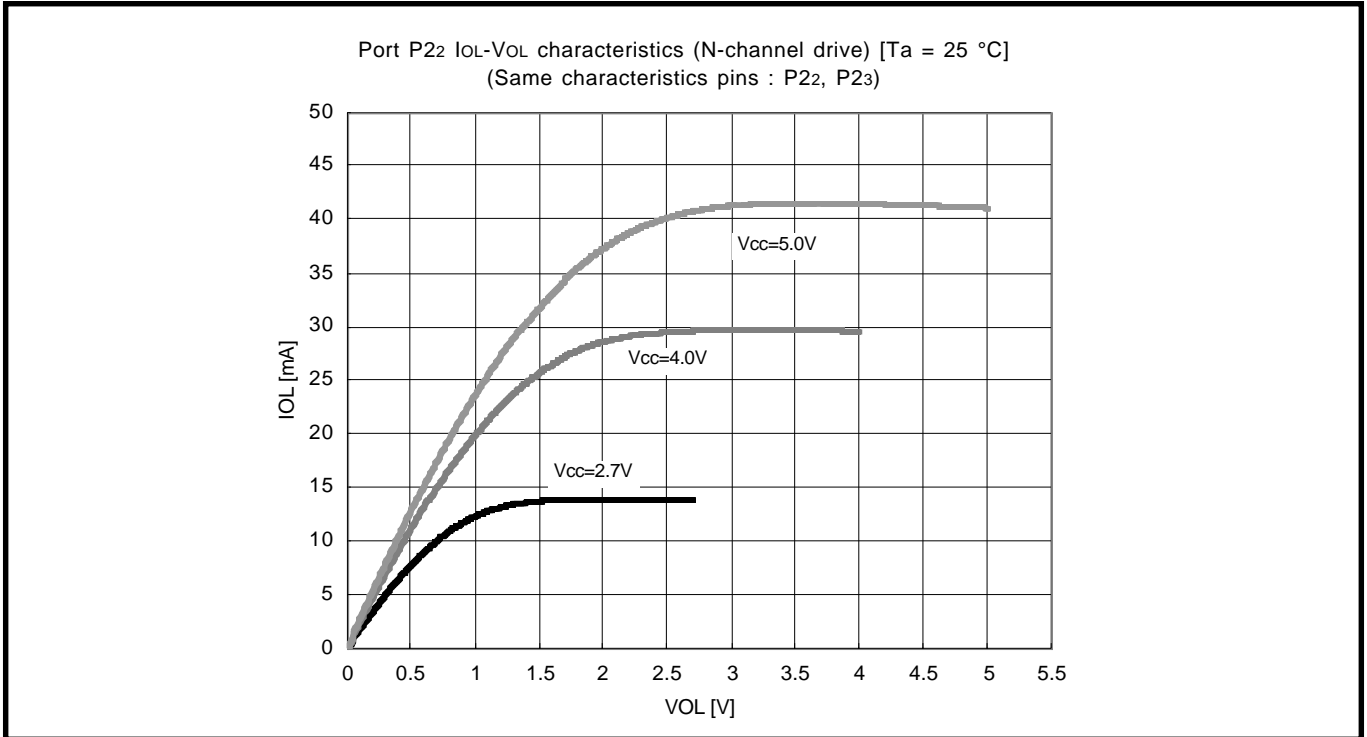


Fig. 21 N-channel open-drain output port N-channel side characteristics (Ta = 25 °C)

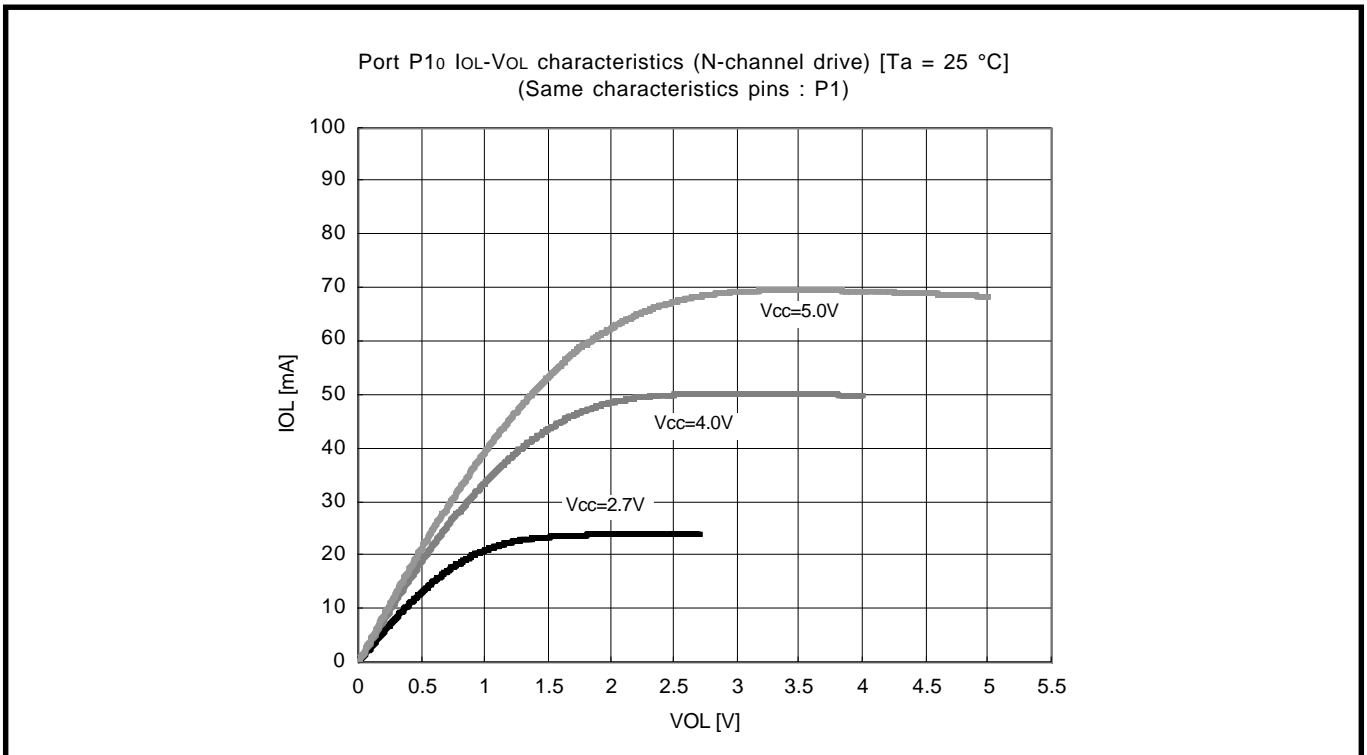


Fig. 22 CMOS large current output port N-channel side characteristics (Ta = 25 °C)

1.5 A-D conversion standard characteristics

(1) Definition of A-D conversion accuracy

The A-D conversion accuracy is defined below.

●Relative accuracy

① Zero transition voltage (V_{0T})

This means an analog input voltage when the actual A-D conversion output data changes from “0” to “1”.

② Full-scale transition voltage (V_{FST})

This means an analog input voltage when the actual A-D conversion output data changes from “1023” to “1022”.

③ Linearity error

This means a deviation from the lone between V_{0T} and V_{FST} of a converted value between V_{0T} and V_{FST} .

④ Differential non-linearity error

This means a deviation from the input potential difference required to change a converted value between V_{0T} and V_{FST} by 1 LSB of the 1 LSB at the relative accuracy.

●Absolute accuracy

This means a deviation from the ideal characteristics between 0 to V_{REF} of actual A-D conversion characteristics.

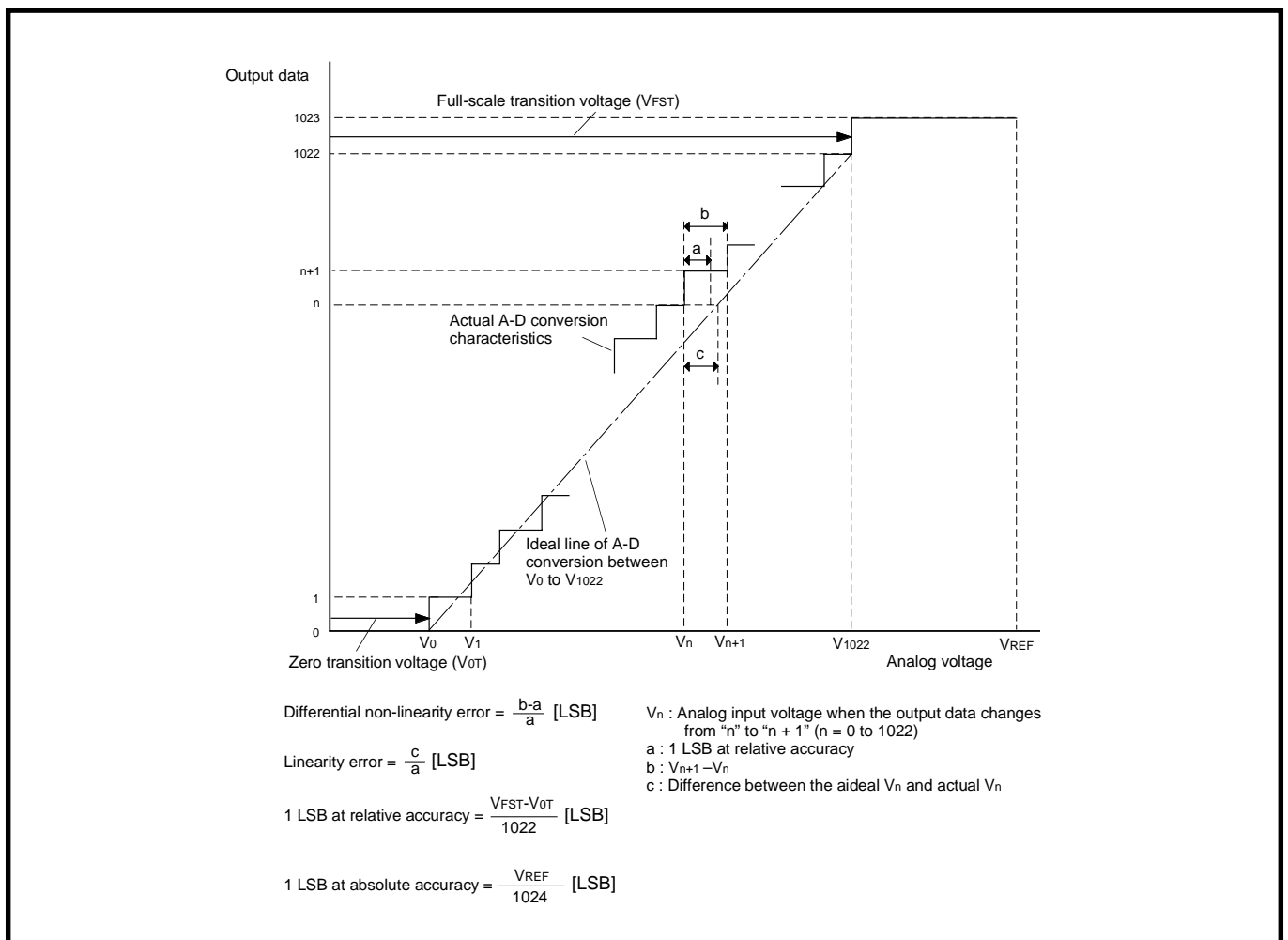


Fig. 23 Definition of A-D conversion accuracy

(2) A-D conversion standard characteristics

Figure. 24 – Figure. 27 show the A-D conversion standard characteristics of flash memory version, mask ROM version, and PROM version, respectively.

The thick lines of the graph indicate the absolute precision errors, These are expressed as the deviation from the ideal value when the output code changes. For example, the change in output code from 256 to 257 should occur at 1280 mV, but the measured value is 2.5 mV. Accordingly, the measured point of change is $1280 + 2.5 = 1282.5$ mV.

The thin lines of the graph indicate the input voltage width for which the output code is constant. For example, the measured input voltage width for which the output code is 256 is 5.0 mV, so that the differential non-linear error is $5.0 - 5.0 = 0$ mV (0 LSB).

8507F8A A-D CONV. ERROR & STEP WIDTH

= 5.12 [V] : VREF = 5.12 [V]
= 12 [MHz] : Ta = 25 [deg.]

Zero transition voltage	:	7.188 [mV]	
Full-scale transition voltage	:	5122.500 [mV]	
Differential non-linearity error	:	-3.911 [mV]	-0.781 [LSB]
Linearity error	:	6.245 [mV]	1.248 [LSB]
Absolute accuracy	:	11.562 [mV]	2.312 [LSB]

— Error
— 1LSB Width (Absolute accuracy error)

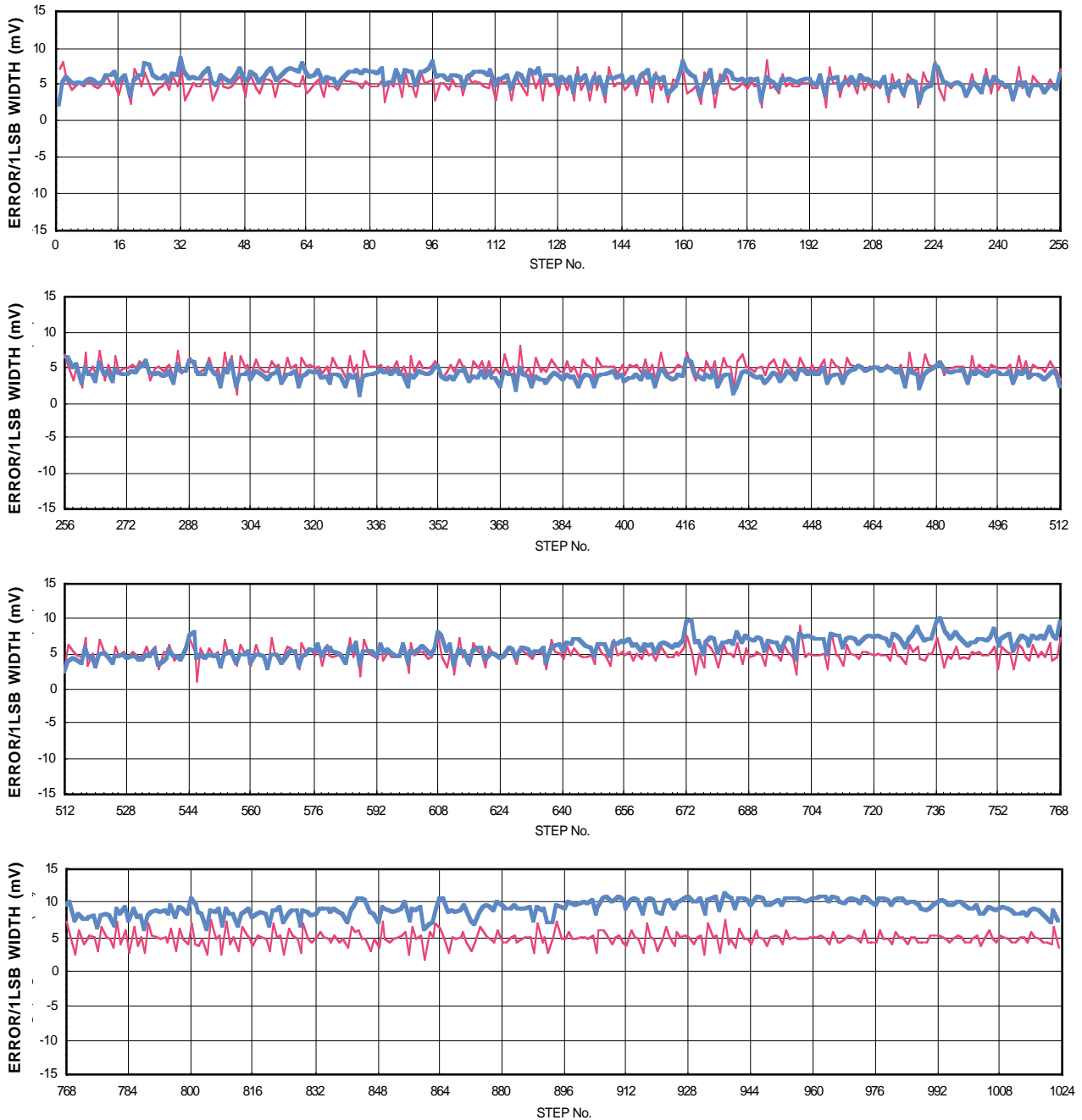


Fig. 24 Flash memory version (M38507F8A) A-D conversion standard characteristics (XIN=12MHz)

M38507F8A A-D CONVERTER ERROR & STEP WIDTH MEASUREMENT

VCC = 5.12 [V], VREF = 5.12 [V]
XIN = 8 [MHz], Ta = 25 [deg.]

Zero transition voltage	:	10.625 [mV]	
Full-scale transition voltage	:	5122.812 [mV]	
Differential non-linearity error	:	1.719 [mV]	: 0.344 [LSB]
Linearity error	:	-5.659 [mV]	: -1.131 [LSB]
Absolute accuracy	:	8.906 [mV]	: 1.781 [LSB]

— (Blue)	: Error (Absolute accuracy error)
— (Red)	: 1LSB Width

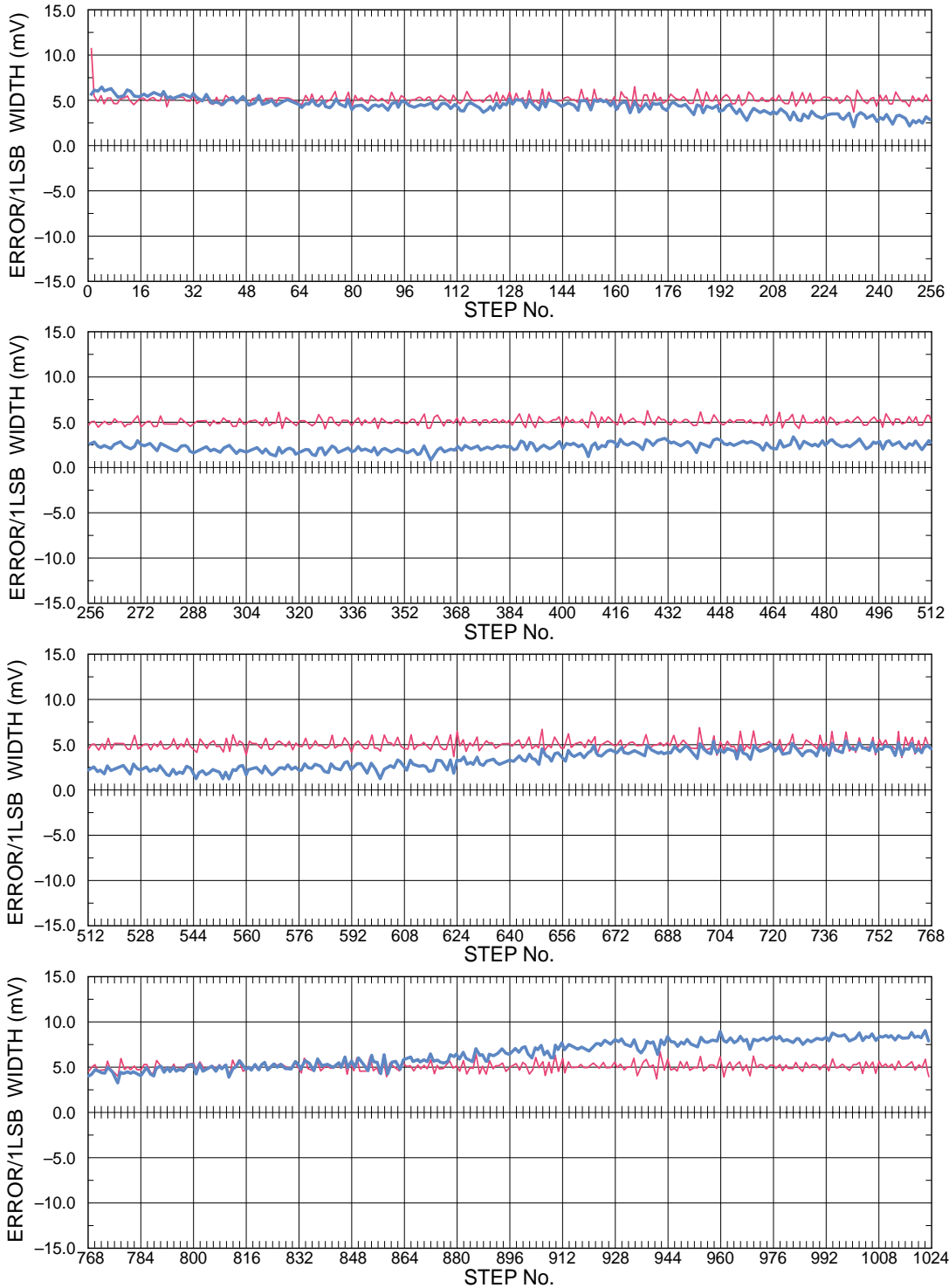


Fig. 25 Flash memory version (M38507F8A) A-D conversion standard characteristics (XIN=8MHz)

M38503M2A, M38503M4A, M38504M6A, M38507M8A A-D CONV. ERROR & STEP WIDTH

V_{CC} = 5.12 [V] : V_{REF} = 5.12 [V]

X_{IN} = 12 [MHz] : T_a = 25 [deg.]

Zero transition voltage : -2500 [mV]
 Full-scale transition voltage : 5110.000 [mV]
 Differential non-linearity error : -4.846 [mV] -.969 [LSB]
 Linearity error : 11.411 [mV] -2.281 [LSB]
 Absolute accuracy : -7.500 [mV] -1.500 [LSB]

— Error
 — 1LSB Width (Absolute accuracy error)

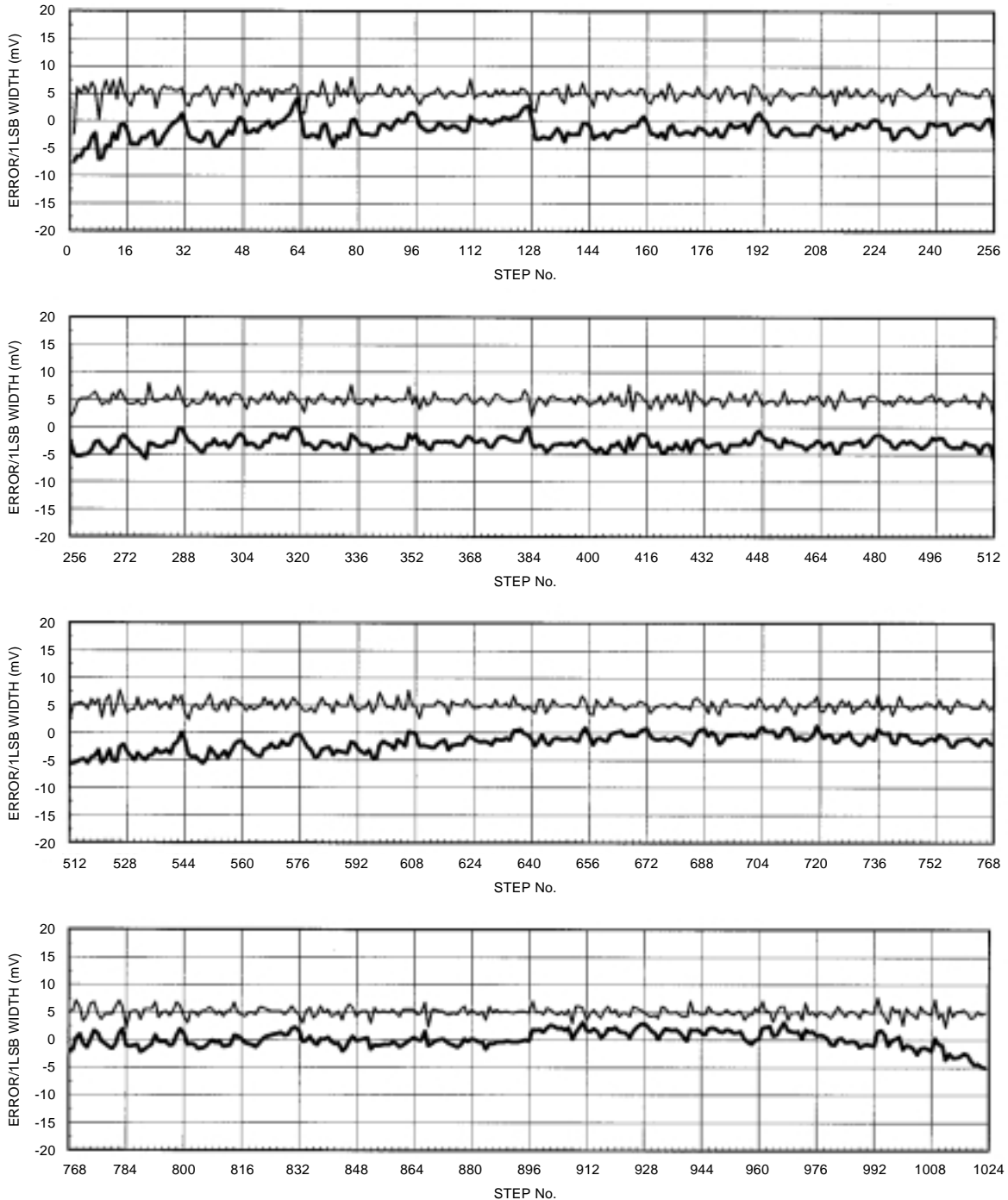


Fig. 26 Mask ROM version (M38503M2A, M38503M4A, M38504M6A, M38507M8A) A-D conversion standard characteristics (X_{IN}=12MHz)

M38503M2A, M38503M4A, M38504M6A, M38507M8A A-D CONV. ERROR & STEP WIDTH

V_{CC} = 5.12 [V] : V_{REF} = 5.12 [V]

X_{IN} = 8 [MHz] : T_a = 25 [deg.]

Zero transition voltage : 11.250 [mV]
 Full-scale transition voltage : 5119.375 [mV]
 Differential non-linearity error : -3.592 [mV] -0.719 [LSB]
 Linearity error : -8.252 [mV] -1.651 [LSB]
 Absolute accuracy : 6.250 [mV] 1.250 [LSB]

— Error
 — 1LSB Width (Absolute accuracy error)

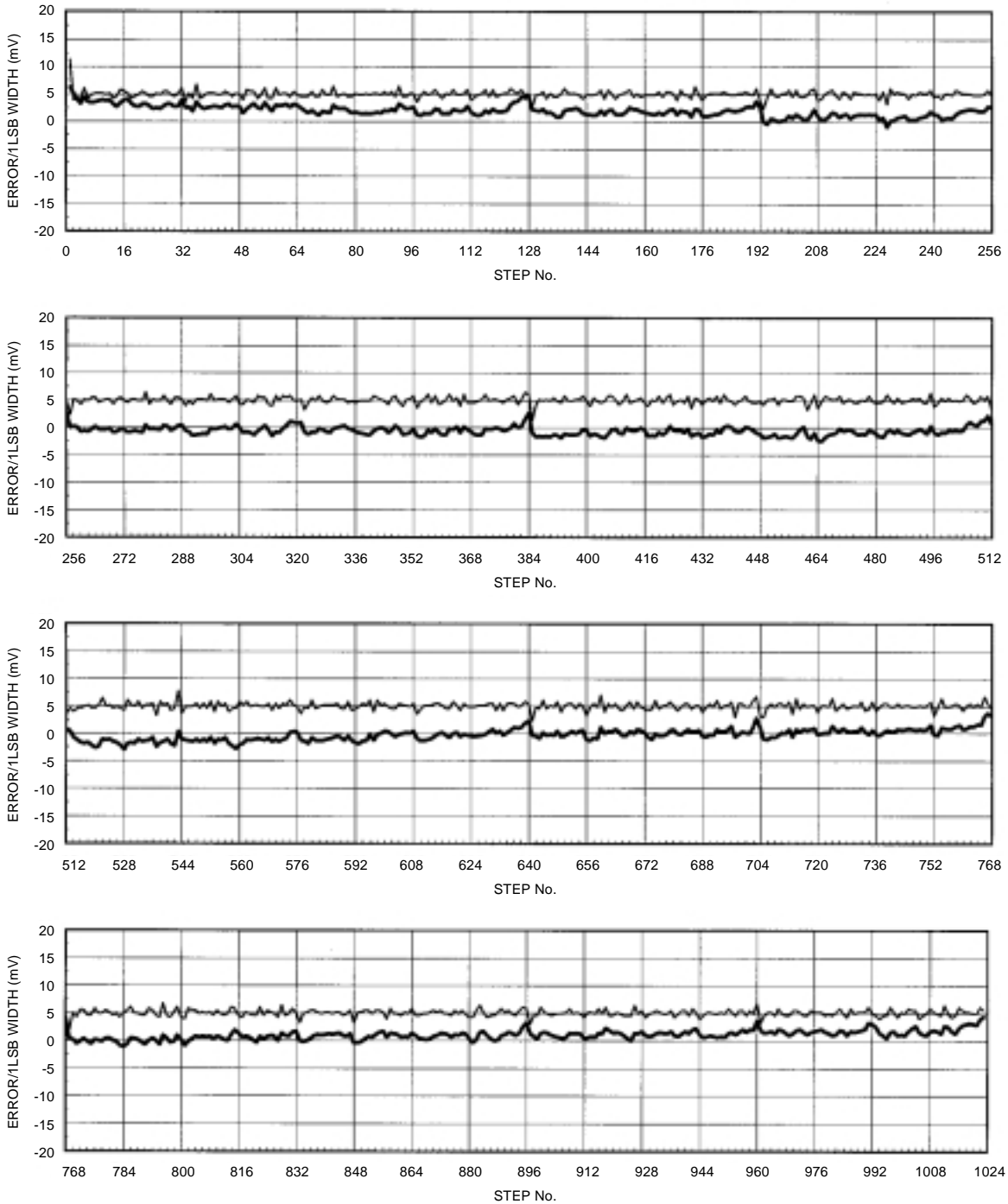


Fig. 27 Mask ROM version (M38503M2A, M38503M4A, M38504M6A, M38507M8A) A-D conversion standard characteristics (X_{IN}=8MHz)

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

Send any inquiries to <http://www.renesas.com/inquiry>.

Notice

1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
2. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
7. Renesas Electronics products are classified according to the following three quality grades: “Standard”, “High Quality”, and “Specific”. The recommended applications for each Renesas Electronics product depends on the product’s quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as “Specific” without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as “Specific” or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is “Standard” unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.
 - “Standard”: Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.
 - “High Quality”: Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.
 - “Specific”: Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) “Renesas Electronics” as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) “Renesas Electronics product(s)” means any product developed or manufactured by or for Renesas Electronics.